

ABSTRACT

5 A sintered aluminum nitride having satisfactorily
densified via holes, which is free from cracking and has
excellent appearance, is produced through firing an aluminum
nitride molding having at least one highly isolated
through-hole for via hole formation. At least one
through-hole for formation of dummy via holes not used for
electrical connection is formed around the highly isolated
10 through-hole for via hole formation, and the through-hole
for dummy via hole formation is also filled with a conductive
paste. Thereafter, the aluminum nitride molding is fired
into the sintered aluminum nitride.

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